

800mA Low Dropout Positive Regulator

FEATURES

- Dropout Voltage 1.2V at 800mA Output Current.
- Fast Transient Response.
- Line Regulation, typical at 0.015%.
- Load Regulation, typical at 0.1%.
- Current Limiting and Thermal Protection.
- Adjustable Output Voltage or Fixed at 1.8V, 2.5V and 3.3V.
- Standard 3-Pin Power Packages.

APPLICATIONS

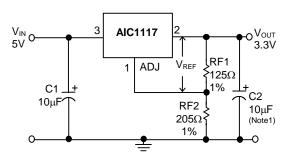
- · Active SCSI Terminators.
- · Post Regulators for Switching Supplies.
- · Battery Chargers.
- PC Add-On Card.

■ DESCRIPTION

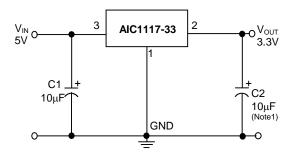
The AIC1117 is a low dropout, three terminals regulator designed to provide output current up to 800mA. The device is available in an adjustable version and fixed output voltage of 1.8V, 2.5V and 3.3V. Dropout voltage of maximum of 1.4V is guaranteed at 800mA output current. The quality of low dropout voltage and fast transient response make this device ideal for low voltage microprocessor applications.

The AlC1117 requires output capacitance of a minimum of $10\mu\text{F}$ for stability. Built-in output current limiting and thermal limiting provide maximal protection to the AlC1117 against fault conditions.

■ TYPICAL APPLICATION CIRCUIT



Adjustable Voltage Regulator



Fixed Voltage Regulator

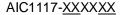
 $V_{REF}=V_{OUT}-V_{ADJ}=1.25V$ (typ.) $V_{OUT}=V_{REF}$ x (1+RF2/RF1)+ I_{ADJ} x RF2 $I_{ADJ}=55\mu A$ (typ.)

- C1 needed if device is far away from filter capacitors.
- (2) C2 required for stability.

TEL: 886-3-5772500



ORDERING INFORMATION



PACKING TYPE
TR: TAPE & REEL
TB: TUBE

PACKAGING TYPE
E: TO-252
M: TO-263
T: TO-220
Y: SOT-223

P: Lead Free Commercial
G: Green Package

OUTPUT VOLTAGE
DEFAULT:ADJUSTABLE

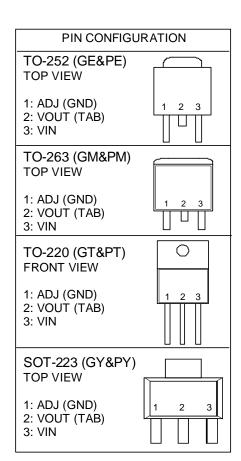
18: 1.8V 25: 2.5V 33: 3.3V

Example: AIC1117-25GETR

→ 2.5V version in TO-252 Green Package & Taping & Reel

Packing Type AIC1117-25PYTR

→ 2.5V version in SOT-223 Lead Free Package & Taping & Reel



SOT-223 Marking

Part No.	GY	PY
AIC1117	AK17G	AK17P
AIC1117-18	AK18G	AK18P
AIC1117-25	AK25G	AK25P
AIC1117-33	AK33G	AK33P



ABSOLUTE MAXIMUM RATINGS

	7V
	-40°C to 85°C
	_65°C to 150°C
	125°C
	260°C
TO-220	3°C /W
TO-252	12.5°C /W
SOT-223	15°C /W
TO-263	3°C /W
TO-252	100°C/W
TO-263	60°C /W
SOT-223	155°C /W
TO-220	50°C /W
	TO-220_ TO-252_ SOT-223_ TO-263_ TO-252_ TO-263_ SOT-223_

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

TEST CIRCUIT

Refer to TYPICAL APPLICATION CIRCUIT.



ELECTRICAL CHARACTERISTICS

(V_{IN}=5V, T_A=25°C, I_O=10mA, unless otherwise specified) (Note2)

PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Reference Voltage	AIC1117 (ADJ), T _J =25°C	1.238	1.25	1.262	V	
Reference voltage	0°C≤TJ≤125°C	1.225	1.25	1.275]	
	AIC1117-18, V _{IN} =3.3V	1.78	1.8	1.82		
Output Voltage	AIC1117-25, V _{IN} =5V	2.47	2.5	2.53	V	
	AIC1117-33, V _{IN} =5V	3.26	3.30	3.33		
	2.65≤V _{IN} ≤7V, V _{OUT} =1.25V		0.015	0.2		
Line Regulation	T _J =25°C		0.015	0.2	%	
	0°C≤TJ≤125°C		0.035	0.2		
	T _J =25°C		0.1	0.3		
Load Regulation	10mA ≤I _O ≤800mA		0.1	0.3	%	
Ç	0°C≤TJ≤125°C		0.2	0.4		
Dropout Voltage	ΔV_{OUT} , ΔV_{REF} =1%		1.2	1.4	V	
Dropout Voltage	10mA≤l _O ≤800mA		1.2	1.4	v	
Current Limit		0.85			А	
Adjusted Pin Current (I _{ADJ})	2.65≤V _{IN} ≤7V	55		120	^	
Aujusteu Fiii Guirent (IADJ)	10mA≤I _O ≤ 800mA			120	μА	
Adjusted Pin Current Change	2.65≤V _{IN} ≤7V		0.2	5	μА	
(Δl _{ADJ})	10mA≤l _O ≤800mA		0.2 5		μΑ	
Temperature Stability I _O =0.5A			0.5		%	
Minimum Load Current			5	10	mA	
GND Current	2.65≤V _{IN} ≤7V		10	14	mA	
RMS Output Noise (% of V _{OUT})	10Hz ≤ f ≤ 10KHz		0.003		%	
Ripple Rejection Ratio	120Hz input ripple C _{OUT} =25μF	60	72		dB	

Note 1: To avoid output oscillation, aluminum electrolytic output capacitor is recommended and ceramic capacitor is not suggested.

Note 2: Specifications are production tested at T_A=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).



TYPICAL PERFORMANCE CHARACTERISTICS

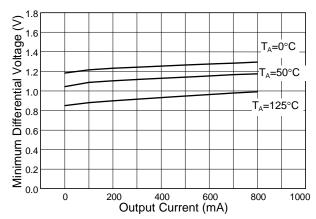


Fig. 1 AIC1117 (ADJ) Dropout Voltage

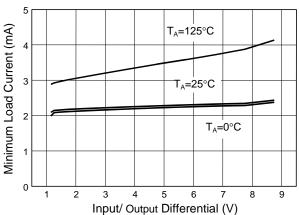


Fig. 2 Minimum Load Current (Adjustable Version)

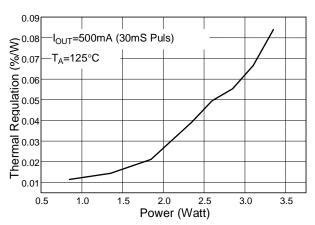


Fig. 3 AIC1117 (ADJ) Power vs. Thermal Regulation

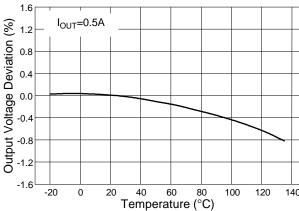


Fig. 4 AIC1117 (ADJ) Temperature Stability

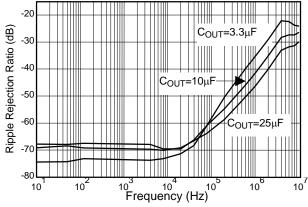


Fig. 5 AIC1117 (ADJ) Ripple Rejection Ratio (dB)



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

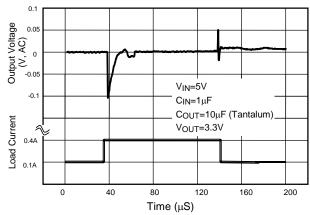


Fig. 6 Load Transient Response

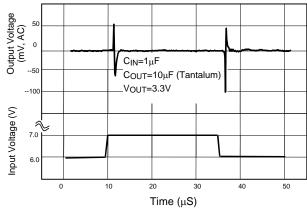


Fig. 7 Line Transient Response

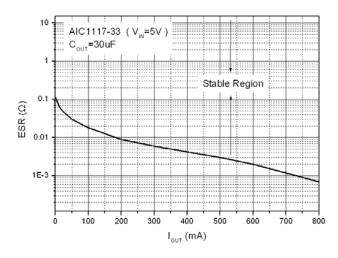


Fig. 8 Region of Stable C_{OUT} ESR vs. Load Current

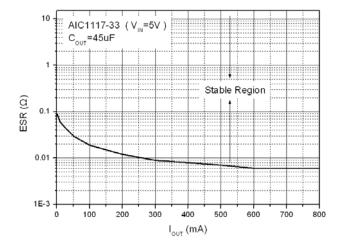
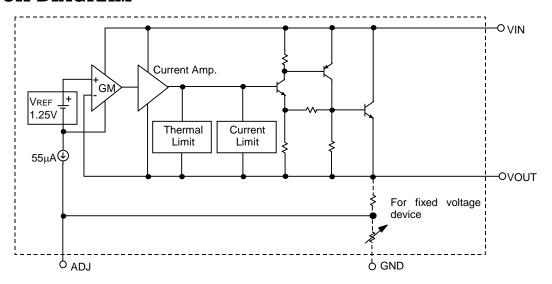


Fig. 9 Region of Stable C_{OUT} ESR vs. Load Current



BLOCK DIAGRAM



■ PIN DESCRIPTIONS

ADJ PIN - Providing V_{REF} =1.25V (typ.) for adjustable V_{OUT} . V_{REF} = V_{OUT} - V_{ADJ} and I_{ADJ} =55 μA (typ.)

(GND PIN - Power ground.)

VOUT PIN - Adjustable output voltage.

VIN PIN - Power Input.



APPLICATION INFORMATION

INPUT-OUTPUT CAPACITORS

Linear regulators require input and output capacitors to maintain stability. Input capacitor at $10\mu F$ with a $10\mu F$ aluminum electrolytic output capacitor is recommended. To avoid oscillation, it is recommended to follow Fig. 8, 9 to choose proper capacitor specifications.

POWER DISSIPATION

The AIC1117 obtains thermal-limiting circuitry, which is designed to protect the device against overload condition. For continuous load condition, maximum rating of junction temperature must not be exceeded. It is important to pay more attention in thermal resistance. It includes junction to case, junction to ambient. The maximum power dissipation of AIC1117 depends on the thermal resistance of its case and circuit board, the temperature difference between the die junction and ambient air, and the rate of airflow. The rate of

temperature rise is greatly affected by the mounting pad configuration on the PCB, the board material, and the ambient temperature. When the IC mounting with good thermal conductivity is used, the junction temperature will be low even when large power dissipation applies.

The power dissipation across the device is

$$P = I_{OUT} (V_{IN} - V_{OUT}).$$

The maximum power dissipation is:

$$P_{MAX} = \frac{(T_{J\text{-max}} - T_{A})}{R\theta_{IA}}$$

Where T_{J-max} is the maximum allowable junction temperature (125°C), and T_A is the ambient temperature suitable in application.

As a general rule, the lower temperature is, the better reliability of the device is. So the PCB mounting pad should provide maximum thermal conductivity to maintain low device temperature.

APPLICATION EXAMPLES

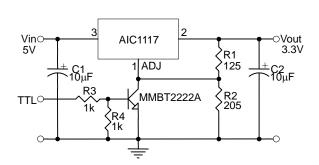


Fig. 10 V_{OUT}=3.3V with Shutdown

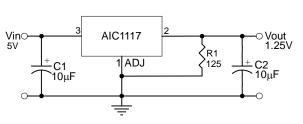


Fig. 12 V_{OUT}=1.25V Application Circuit

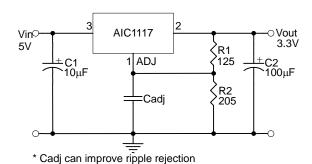


Fig. 11 Improving Ripple Rejection

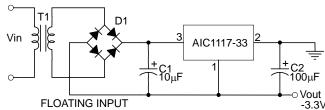
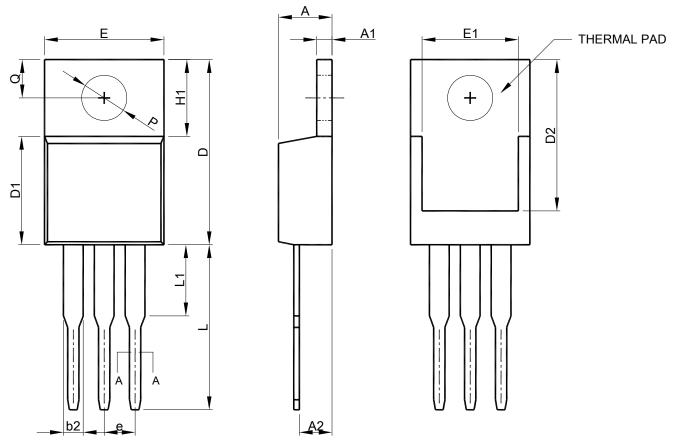


Fig. 13 Low Dropout Negative Supply



PHYSICAL DIMENSIONS (unit: mm)

● TO-220



	(
BASE METAL/	
SECTION A-	4

Note: 1. Refer to JEDEC TO-220AB.

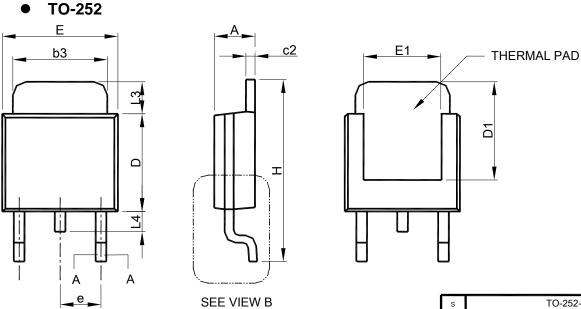
2. Dimension "E" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.

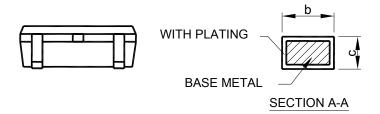
WITH PLATING _

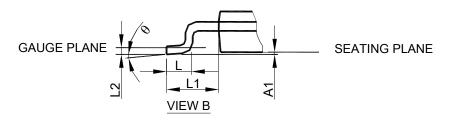
- 3. Dimension "D1" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

S Y	TO-220		
M B O	MILLIMETERS		
L	MIN.	MAX.	
Α	3.56	4.82	
A1	0.51	1.39	
A2	2.04	2.92	
b	0.38	1.01	
b2	1.15	1.77	
С	0.35	0.61	
D	14.23	16.51	
D1	8.38	9.02	
D2	11.75	12.88	
Е	9.66	10.66	
E1	6.86	8.90	
е	2.54 BSC		
H1	5.85	6.85	
L	12.70	14.73	
L1		6.35	
Р	3.54	4.08	
Q	2.54	3.42	
_			









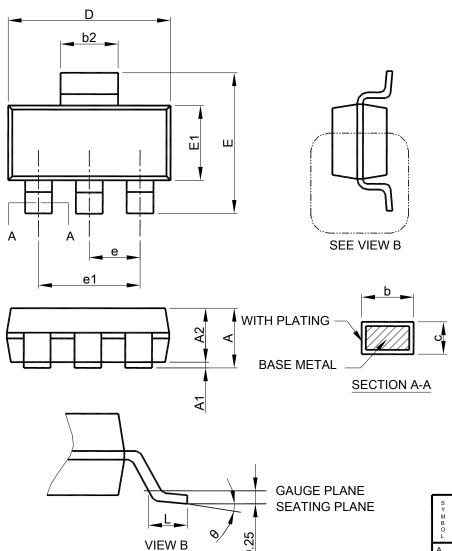
S	S TO-252-3L MILLIMETERS	
M B O		
O L	MIN.	MAX.
Α	2.19	2.38
A1	0.00	0.13
b	0.64	0.89
b3	4.95	5.46
С	0.46	0.61
c2	0.46	0.89
D	5.33	6.22
D1	4.60	6.00
Е	6.35	6.73
E1	3.90	5.46
е	2.28 BSC	
Н	9.40	10.41
L	1.40	1.78
L1	2.67 REF	
L2	0.51 BSC	
L3	0.89	2.03
L4		1.02
θ	0°	8°

Note: 1. Refer to JEDEC TO-252AA and AB.

- 2. Dimension "E" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
- 3. Dimension "D" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



• SOT-223



Note: 1. Refer to JEDEC TO-261AA.

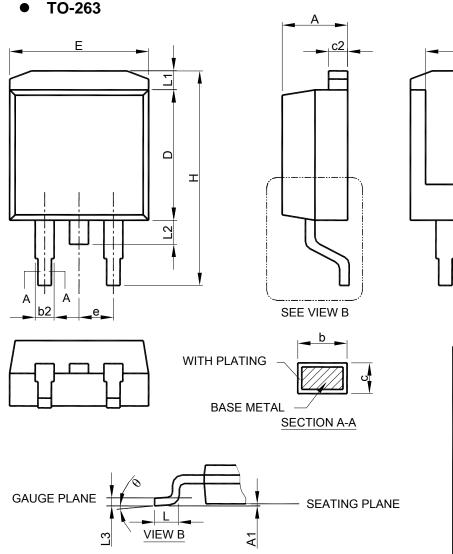
- 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
- 3. Dimension "E1" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

S Y	SOT-223		
M	MILLIMETERS		
B O L	MIN.	MAX.	
Α		1.80	
A1	0.02	0.10	
A2	1.55	1.65	
b	0.66	0.84	
b2	2.90	3.10	
С	0.23	0.33	
D	6.30	6.70	
Е	6.70	7.30	
E1	3.30	3.70	
е	2.30 BSC		
e1	4.60 BSC		
L	0.90		
θ	0°	8°	

THERMAL PAD

2





Note: 1	Refer to	IEDEC TO-263AB	

- 2. Dimension "E" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
- 3. Dimension "D" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

S Y	TO-263-3L		
M B	MILLIMETERS		
O L	MIN.	MAX.	
Α	4.06	4.83	
A1	0.00	0.25	
b	0.51	0.99	
b2	1.14	1.78	
С	0.38	0.74	
c2	1.14	1.65	
D	8.38	9.65	
D1	6.86		
Е	9.65	10.67	
E1	6.23		
е	2.54 BSC		
Н	14.61	15.88	
L	1.78	2.79	
L1		1.68	
L2		1.78	
L3	0.25 BSC		
θ	0°	8°	

Note:

Information provided by AIC is believed to be accurate and reliable. However, we cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in an AIC product; nor for any infringement of patents or other rights of third parties that may result from its use. We reserve the right to change the circuitry and specifications without notice.

Life Support Policy: AIC does not authorize any AIC product for use in life support devices and/or systems. Life support devices or systems are devices or systems which, (I) are intended for surgical implant into the body or (ii) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for LDO Voltage Regulators category:

Click to view products by AIC manufacturer:

Other Similar products are found below:

AP7363-SP-13 L79M05TL-E AP7362-HA-7 PT7M8202B12TA5EX TCR3DF185,LM(CT TCR3DF45,LM(CT TLE4473G V52 059985X NCP4687DH15T1G 701326R NCV8170AXV250T2G AP7315-25W5-7 AP2111H-1.2TRG1 ZLDO1117QK50TC AZ1117ID-ADJTRG1 TCR3DG12,LF MIC5514-3.3YMT-T5 SCD7912BTG NCP154MX180270TAG SCD33269T-5.0G NCV8170BXV330T2G NCV8170BMX330TCG NCV8170AMX120TCG NCP706ABMX300TAG NCP153MX330180TCG NCP114BMX075TCG MC33269T-3.5G CAT6243-ADJCMT5T TCR3DG33,LF TCR4DG35,LF TAR5S15U(TE85L,F) TAR5S18U(TE85L,F) TCR3UG19A,LF TCR4DG105,LF MPQ2013AGG-5-P NCV8170AMX360TCG TLE4268GSXUMA2 NCP715SQ15T2G MIC5317-3.0YD5-T5 NCV563SQ18T1G NCP715MX30TBG NCV8702MX25TCG NCV8170BXV120T2G MIC5317-1.2YD5-T5 NCV8170AMX150TCG NCV8170BMX150TCG AP2213D-3.3TRG1 NCV8170BMX120TCG NCV8170BMX310TCG NCV8170BMX360TCG